

NP180N055TUK

MOS FIELD EFFECT TRANSISTOR

R07DS0593EJ0100 Rev.1.00 Dec 12, 2011

Description

The NP180N055TUK is N-channel MOS Field Effect Transistor designed for high current switching applications.

Features

• Super low on-state resistance

 $R_{DS(on)} = 1.40 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, I_D = 90 \text{ A})$

- Low C_{iss} : $C_{iss} = 10700 \text{ pF TYP.} (V_{DS} = 25 \text{ V})$
- Designed for automotive application and AEC-Q101 qualified

Ordering Information

Part No.	Lead Plating	Pac	Package	
NP180N055TUK-E1-AY *1	Pure Sn (Tin)	Tape 800 p/reel	Taping (E1 type)	TO-263-7pin
NP180N055TUK-E2-AY *1			Taping (E2 type)	(MP-25ZT)

Note: *1 Pb-free (This product does not contain Pb in the external electrode)

Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V _{GS} = 0 V)	V _{DSS}	55	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	±20	V
Drain Current (DC) (T _C = 25°C)	I _{D(DC)}	±180	A
Drain Current (pulse) *1	I _{D(pulse)}	±720	A
Total Power Dissipation (T _C = 25°C)	P _{T1}	348	W
Total Power Dissipation (T _A = 25°C)	P _{T2}	1.8	W
Channel Temperature	T _{ch}	175	°C
Storage Temperature	T _{stg}	-55 to 175	°C
Repetitive Avalanche Current *2	I _{AR}	66	A
Repetitive Avalanche Energy *2	E _{AR}	435	mJ

Notes: *1 T_C = 25°C, $P_W \le 10~\mu s$, Duty Cycle $\le 1\%$

Thermal Resistance

^{*2} R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V

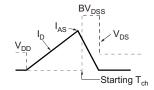
Electrical Characteristics $(T_A = 25^{\circ}C)$

Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	V _{DS} = 55 V, V _{GS} = 0 V	
Gate Leakage Current	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	
Gate to Source Threshold Voltage	$V_{GS(th)}$	2.0	3.0	4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Forward Transfer Admittance *1	y _{fs}	75	150	_	S	V _{DS} = 5 V, I _D = 90 A	
Drain to Source On-state Resistance *1	R _{DS(on)}	_	1.15	1.40	mΩ	V _{GS} = 10 V, I _D = 90 A	
Input Capacitance	C _{iss}	_	10700	16050	pF	V _{DS} = 25 V	
Output Capacitance	Coss	_	1200	1800	pF	V _{GS} = 0 V	
Reverse Transfer Capacitance	C _{rss}	_	380	690	pF	f = 1 MHz	
Turn-on Delay Time	t _{d(on)}	_	38	90	ns	V _{DD} = 28 V, I _D = 90 A	
Rise Time	t _r	_	20	50	ns	V _{GS} = 10 V	
Turn-off Delay Time	t _{d(off)}	_	140	280	ns	$R_G = 0 \Omega$	
Fall Time	t _f	_	14	40	ns		
Total Gate Charge	Q_G	_	196	294	nC	V _{DD} = 44 V	
Gate to Source Charge	Q _{GS}	_	51	_	nC	V _{GS} = 10 V	
Gate to Drain Charge	Q_{GD}	_	45	_	nC	I _D = 180 A	
Body Diode Forward Voltage *1	$V_{F(S-D)}$	_	0.9	1.5	V	I _F = 180 A, V _{GS} = 0 V	
Reverse Recovery Time	t _{rr}	_	83	_	ns	I _F = 180 A, V _{GS} = 0 V	
Reverse Recovery Charge	Q _{rr}	_	145	_	nC	di/dt = 100 A/μs	

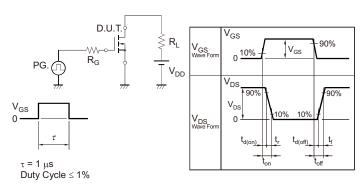
Note: *1 Pulsed test

TEST CIRCUIT 1 AVALANCHE CAPABILITY

D.U.T.



TEST CIRCUIT 2 SWITCHING TIME

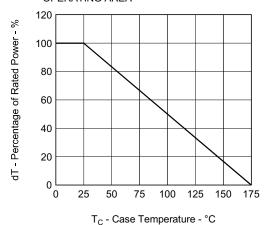


TEST CIRCUIT 3 GATE CHARGE

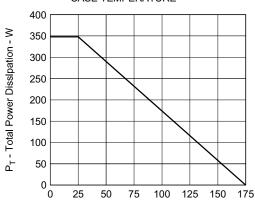
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Typical Characteristics $(T_A = 25^{\circ}C)$

DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

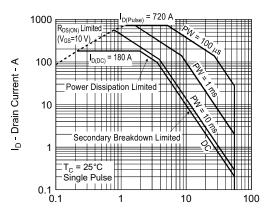


TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



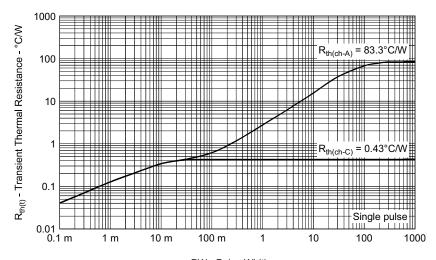
T_C - Case Temperature - °C

FORWARD BIAS SAFE OPERATING AREA

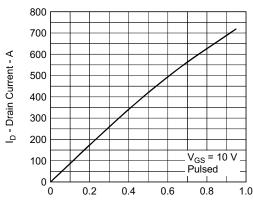


V_{DS} - Drain to Source Voltage - V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

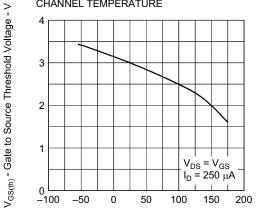


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



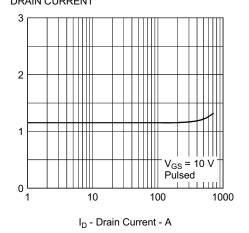
V_{DS} - Drain to Source Voltage - V

GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE

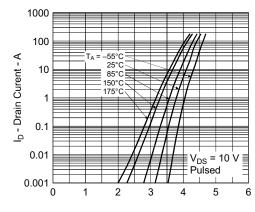


 $\rm T_{ch}$ - Channel Temperature - $^{\circ}\rm C$

DRAIN TO SOURCE ON-STATE RESISTANCE vs. **DRAIN CURRENT**

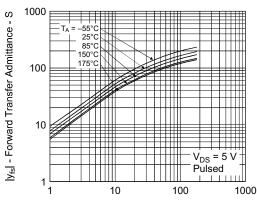


FORWARD TRANSFER CHARACTERISTICS



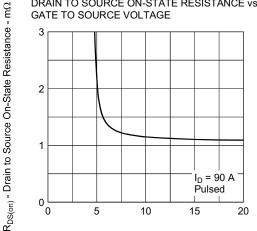
V_{GS} - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



I_D - Drain Current - A

DRAIN TO SOURCE ON-STATE RESISTANCE vs.

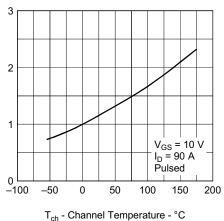


V_{GS} - Gate to Source Voltage - V

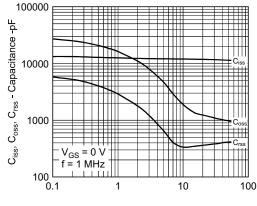
 $R_{DS(on)}$ - Drain to Source On-State Resistance - $m\Omega$

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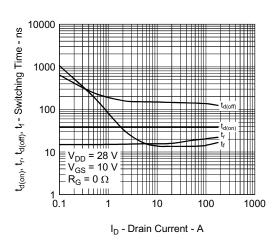


CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

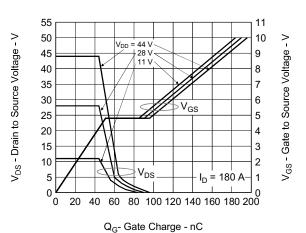


V_{DS} - Drain to Source Voltage - V

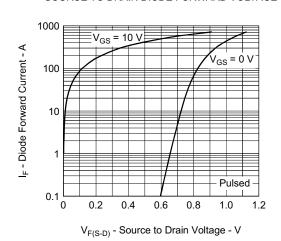
SWITCHING CHARACTERISTICS



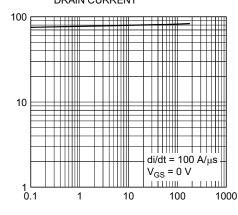
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE



REVERSE RECOVERY TIME vs. DRAIN CURRENT

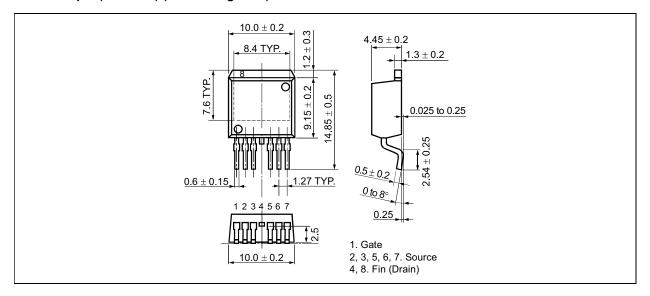


I_F - Drain Current - A

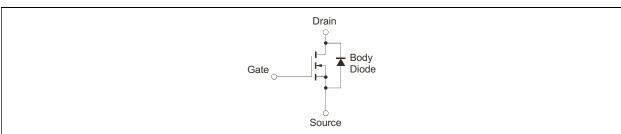
t_{rr} - Reverse Recovery Time - ns

Package Drawing (Unit: mm)

TO-263-7pin (MP-25ZT) (Mass: 1.5 g TYP.)



Equivalent Circuit



Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

NP180N055TUK Data Sheet

		Description		
Rev.	Date	Page	Summary	
1.00	Dec 12, 2011	_	First Edition Issued	

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